

#17

TRACEY BELL.
4.16.02

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Rich Fogal and Michael B. Ball

Serial No.: 09/422,887

Filed: October 21, 1999

For: ANGULARLY OFFSET STACKED DIE
MULTICHIP DEVICE AND METHOD OF
MANUFACTURE



§
§ Group Art Unit: 2822
§
§ Examiner: J. Brophy
§
§ Atty. Docket: 95-0134.05
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RESPONSE TO THE OFFICE ACTION DATED OCTOBER 17, 2001

Certificate of Mailing (37 C.F.R. § 1.8)

Commissioner for Patents

Washington, D.C. 20231

Dear Sir:

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail, postage prepaid, in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on the date below:

2/19/02 Susan Jerome
Date Signature

Applicants herein respond to the Office Action of October 17, 2001. Please amend the above-captioned application as follows.

IN THE DRAWINGS

Applicants are concurrently submitting substitute formal drawings to the Draftsperson. A clean and red-lined version are included in an appendix to this Response.

IN THE SPECIFICATION

Applicants are concurrently submitting a clean substitute specification without the claims and in the paragraph-numbered form requested by the Patent Office. The substitute specification contains no new matter. Applicants are also submitting a marked-up version of the substitute